Polymer

Surface Mount Thermistor

PTC Devices No.10

Wayon Electronics Co., Ltd.
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LP-ISML110/12F

Features

- Small size 0805
- Low resistance
- Lead-free and compliant with the European Union RoHS Directive (EU)2015/863
- Fast time-to-trip
- Agency Recognition: UL

Product Dimension (mm)

Part Number	Α	В	С	D	
	Тур.	Тур.	Тур.	Тур.	
LP-ISML110/12F	2.30±0.20	1.60±0.20	0.50±0.20	0.45±0.10	

Electrical Characteristics

Davit Neverlage	Ін	lτ	V _{max}	I _{max}	T _{trip}		Pd typ	R _{min}	R _{1max}
Part Number	(A)	(A)	(V)	(A)	Current(A) Time(S)		(W)	(Ω)	(Ω)
LP-ISML110/12F	1.1	2.2	12	50	8.0	5.0	0.6	0.030	0.105

 I_{H} =Hold current: maximum current at which the device will not trip at 25°C still air.

 $I_{T}\text{=}Trip$ current: minimum current at which the device will always trip at 25°C still air.

V_{max}=Maximum voltage device can withstand without damage at rated current.

 I_{max} =Maximum fault current device can withstand without damage at rated voltage.

 T_{trip} =Maximum time to trip(s) at assigned current.

Pd_{typ}=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

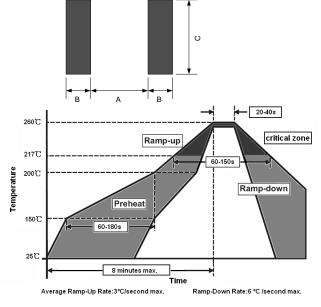
R_{min}=Minimum device resistance at 25°C prior to tripping.

R_{1max}=Maximum device resistance measured in the nontripped state 1 hour post reflow.

Thermal Derating

LP-ISML110/12F	Maximum ambient operating temperature(°C)							
	-40	-20	0	25	50	60	70	85
Hold Current (A)	1.95	1.65	1.35	1.10	0.80	0.70	0.40	0.25
Trip Current (A)	4.90	3.80	3.30	2.40	2.00	1.80	1.20	1.00

Solder Reflow Recommendation



Se	older Pa	d Layou	ut
Dout Novelson	Α	В	С
Part Number	(mm)	(mm)	(mm)
LP-ISML110/12F	1.20	1.00	1.40

* Recommended reflow methods: IR, vapor phase, hot air oven. **Notes:**

- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Devices are not designed to be wave soldered to the bottom side of the board.

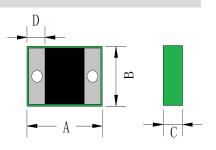
Package Information

Tape & Reel: 4000pcs per reel.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame.

Specifications are subject to change without notice.





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Environmental Specifications

Humidity Aging condition	65°C (±2°C)/90%RH (±5%RH)
Time	504hrs
Requirement	Power on 10mA,PTC won't trip

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DOCUM	ENT: M21356							
REV LET			Wayon Electronics Co., Ltd.					
	D: 3 OF 3	Polymer	Wayon Electronics Co., Ltd.					
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PART NU	JMBER:		Tel: 86-21-50968309 Fax: 86-21-50968310					
LP-ISM	L110/12F	Surface Mount Thermistor	E-mail: <u>market@way-on.com</u> Http://www.way-on.com					
		<u>en</u>						
			ID PTC 使用注意事项					
			ions for SMD PTC Use					
1.			」,超出 PTC 最大电压或最大电流规格值的操作,可能会导致 PTC 出现电					
	弧,阻值升高,	- 去主烧斤。 and the maximum voltage or c	urrent may result in device damage and possible electrical arcing or flame.					
2.			PTC 经过一次回流焊接得出的常规性能,PTC 能够在不同温度对应的电流					
	条件下保持 1/	小时。该电流并不是该型号 PT	C能够适用的长期充电或放电电流的条件。					
	Hold current at all temperatures specified in the SPEC is the conventional performance of PTC obtained by one time reflow welding. PTC can hold 1 hour under current conditions at a given temperature. This current is not the condition							
		arging or discharging current						
3.			在维安指定测试板经过一次回流焊之后的测试。如果客户有二次回流焊或					
	者注塑点胶等其	其他热工序,会对上述参数有	·定程度的衰减。所以需要验证其适用性。					
	The above parameters are concluded from one time of reflow soldering processing the PTC. If there is any further heat							
	generated process like injection or dispensing at the customer's premise, the aforementioned parameters will decrease at certain degree. Therefore the verification test to be conducted is necessary .							
4.			X在 PTC 周围不要设计热源元件,尽量减少外部热源的影响。					
	The PTC is the	ermal sensitive device. It is rec	ommended not to design any heat source devices around it to reduce the					
_	outside heat so		。 旧校学书刊 口径旧 。 旧校学书学会书体合版书体口字旧业体 。 后田口字					
5.	PIC 贴片产品; 相调度切过按测		, 焊接工艺为回流焊。焊接工艺可参考维安推荐的回流焊曲线。如果回流 5。禁止使用手工焊接 PTC, 禁止对线路板其他元件或端子返工时使用热风					
	样価度超过1世4 枪。	子的值,FIC 衍有可能文封锁[]	J。示止使用于工序按FIG,示止对线路极共他几件或墙了					
		esigned for SMT processing w	hich applies reflow soldering. Please refer to the Wayon recommended					
			nperature exceeds the recommended value, the PTC might be damaged.					
	Hand welding rework .	PTC is prohibited. Heat gun is	not allowed to use during the circuit board components or terminals					
6.		田过程中 所使用到的各类注朔;	科、单组份、双组份固化胶粘剂、硅胶,需要对注塑料胶料等材料牌号以及					
0.			保产品及工艺的匹配性,确认不会影响 PTC 性能之后方可使用。					
	When mountin	g or using PTC, all injection m	olding materials, curing adhesives, UV glue , silica gel and cleaning					
			application parameters e.g. temperature, time, and etc to ensure the					
7.		etween the product and the pro 田过程中,不建议使田洪板水面	成在SSIIg Delote use. 发其他清洗剂进行清洗。如必须使用,需要验证各类清洗剂、洗板水以及溶					
1.	利的适用性, 荷	角认不会影响 PTC 性能之后方	可使用。已知对 PTC 有影响的化学药品包括但不仅限于醚类、苯类、酮类					
			。清洗后将产品放置于敞开的环境中至少24小时,将残留的溶剂进行充分					
	的挥发。							
			mended to use circuit board washer water or other cleaning agent. If the applicability of various cleaning agents, washboard water and solvents,					
			performance. The known chemicals that impacts PTC include but not					
	limited to ether	s, benzene homolog, ketones,	lipids and derivates that is of strong solubleness and ruinous. Please					
			least 24 hours to volatilize solvents residuals.					
8.			l、刺等方式作用 PTC 本体,以免引起 PTC 性能衰减。 st by tool during assembling process otherwise it might be a cause of the					
	performance d		st by tool during assembling process otherwise it might be a cause of the					
9.			E塑或打胶,须在尽量短的时间内完成,如贴装与注塑打胶时间间隔超过1					
		引保存,可避免 PTC 长时间暴						
			application, if injection or gluing is needed, it should be completed in as een mounting and injection or gluing surpasses 1 month,, please keep in					
		ment to avoid long air exposu						
10.			使用,重复多次的保护会降低 PTC 的维持电流。					
	PTC is resettal PTC hold curre		all not be taken for use as switch. Multiple times tripping shall lower the					
11.			↓做内膜,禁止使用 TPE 类与 PVC 类等材料做内膜。					
			erial is recommended to use as inner membrane and TPE and PVC type					
	material is inhi							
12.			λ焊接位置距离 PTC 1.5mm 以上,焊接工具温度低于 350℃,焊接铁头与					
	焊点的接触时间		soldering iron welding process, it is suggested that the welding position sh					
			e welding tool temperature should be lower than 350°C, and the contact ti					
	me between so	oldering iron and solder joint sl	nould not exceed 3sec.					
13.			为包装。客户如在库存中发现有包装破损的,立即将产品隔离处理;使用时					
		恢复之前包装状态,做密封保存 istance SMD PTC humidity se	s. nsitivity grade 2, for sealed packaging. If customers find damaged					
			roduct immediately; if there is surplus material, they need to restore the					
	packaging stat	us , and do sealed storage.						
14.			法律法规回收报废,具体原材料组成可参见 MSDS。					
			be treated recycled in accordance with local laws and regulations, and raw					
	material compo	ositions of PPTC can be referre	ea lo Mouo.					

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